COMPLIANT HALOGEN

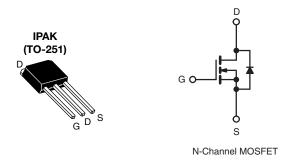
FREE



Vishay Siliconix

E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.) at T _J max. 700			
$R_{DS(on)}$ max. at 25 °C (Ω) $V_{GS} = 10 \text{ V}$ 0.9				
Q _g max. (nC)	34			
Q _{gs} (nC)	4			
Q _{gd} (nC)	8			
Configuration	Single			



FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION			
Package	IPAK (TO-251)		
Lead (Pb)-free and Halogen-free	SiHU6N62E-GE3		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	620	V	
Gate-Source Voltage			V_{GS}	± 30	7 v	
Continuous Drain Current (T. 150 °C)	V _{GS} at 10 V	T _C = 25 °C	°C I _D	6		
Continuous Drain Current (T _J = 150 °C)		T _C = 100 °C		4	А	
Pulsed Drain Current ^a			I _{DM}	12		
Linear Derating Factor				0.63	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	88	mJ	
Maximum Power Dissipation			P_{D}	78	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope T _J = 125 °C		dV/dt	37	\//		
Reverse Diode dV/dt ^d			12	- V/ns		
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.5 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.

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THERMAL RESISTANCE RATINGS					
PARAMETER SYMBOL TYP. MAX. UNIT					
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	1.6	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-					•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	620	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.76	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V		-	± 1	μΑ
			= 620 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}		/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	0.78	0.90	Ω
Forward Transconductance	9fs	V _{DS}	s = 30 V, I _D = 3 A	-	1.8	-	S
Dynamic		•					
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	578	-	pF
Output Capacitance	Coss		$V_{DS} = 100 \text{ V},$		36	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V 0V 400V V 0V		-	31	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{DS} = 0.0$	$V_{DS} = 0 \text{ V to } 496 \text{ V}, V_{GS} = 0 \text{ V}$		87	-	
Total Gate Charge	Qg			-	17	34	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 496 \text{ V}$		4	-	nC
Gate-Drain Charge	Q _{gd}	1			8	-	
Turn-On Delay Time	t _{d(on)}	'		-	12	24	
Rise Time	t _r	V _{DD} :	$V_{DD} = 496 \text{ V}, I_D = 3 \text{ A}, $ $V_{GS} = 10 \text{ V}, R_q = 9.1 \Omega$		10	20	ns
Turn-Off Delay Time	t _{d(off)}	00			22	44	
Fall Time	t _f	-		-	16	32	
Gate Input Resistance	R_{g}	f = 1	MHz, open drain	-	1.3	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	
Pulsed Diode Forward Current	I _{SM}			-	-	12	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 3 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}			-	190	-	ns
Reverse Recovery Charge	Q _{rr}		25 °C, I _F = I _S = 3 A,	-	1.3	-	μC
Reverse Recovery Current	I _{RRM}	dI/dt = 100 A/μs, V _R = 400 V		_	11	_	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

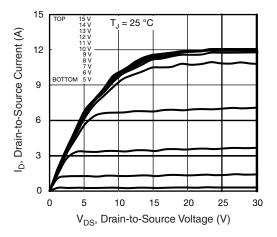


Fig. 1 - Typical Output Characteristics

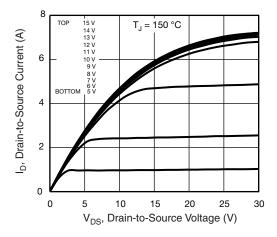


Fig. 2 - Typical Output Characteristics

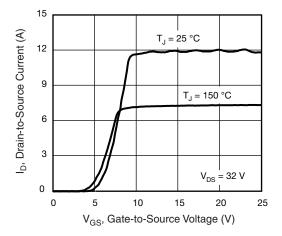


Fig. 3 - Typical Transfer Characteristics

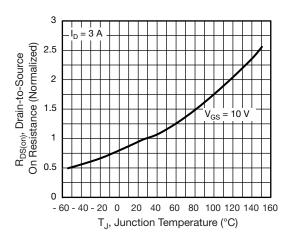


Fig. 4 - Normalized On-Resistance vs. Temperature

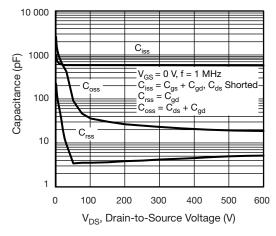


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

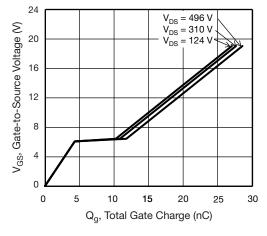


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



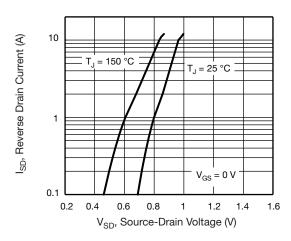


Fig. 7 - Typical Source-Drain Diode Forward Voltage

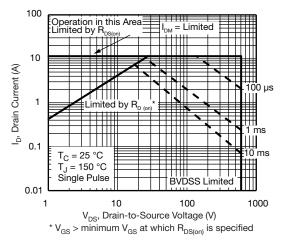


Fig. 8 - Maximum Safe Operating Area

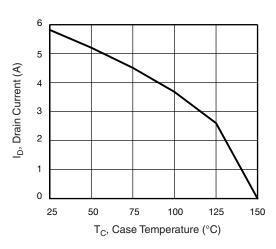


Fig. 9 - Maximum Drain Current vs. Case Temperature

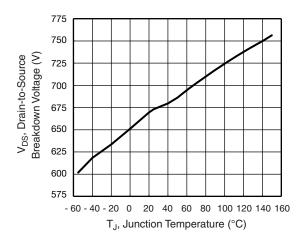


Fig. 10 - Temperature vs. Drain-to-Source Voltage

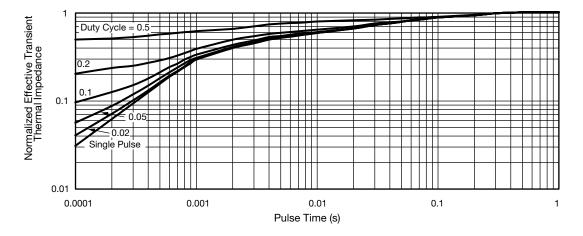


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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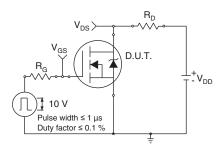


Fig. 12 - Switching Time Test Circuit

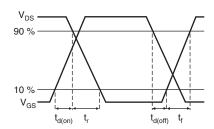


Fig. 13 - Switching Time Waveforms

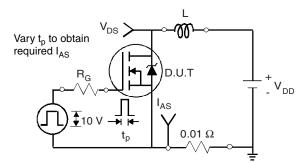


Fig. 14 - Unclamped Inductive Test Circuit

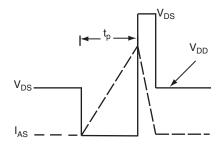


Fig. 15 - Unclamped Inductive Waveforms

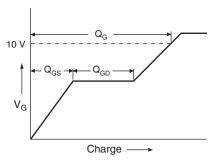


Fig. 16 - Basic Gate Charge Waveform

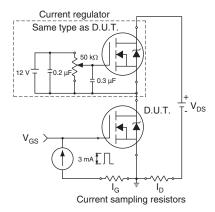
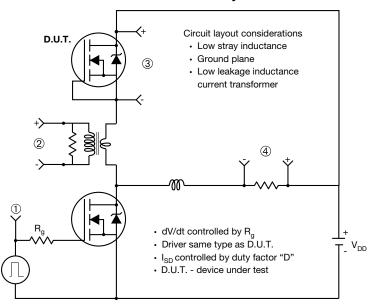


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



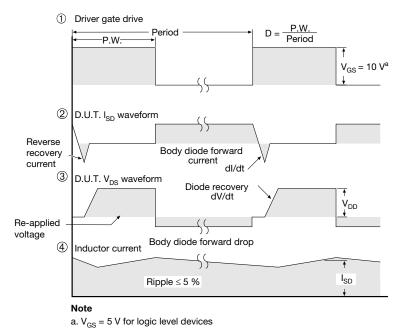


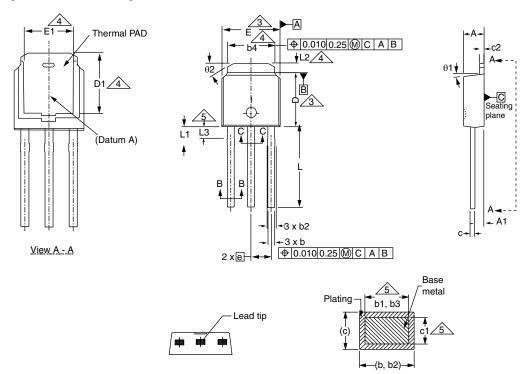
Fig. 18 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91548.





TO-251AA (HIGH VOLTAGE)



Section B - B and C - C

	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
D1	5.21	-	0.205	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
е	2.29	2.29 BSC		2.29 BSC	
L	8.89	9.65	0.350	0.380	
L1	1.91	2.29	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.14	1.52	0.045	0.060	
θ1	0'	15'	0'	15'	
θ2	25'	35'	25'	35'	

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



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